

# NL3S22AH, NL3S22UH

## USB 2.0 + Audio Switch

The NL3S22AH/NL3S22UH is a double-pole/double-throw (DPDT) analog switch for routing high speed differential data and audio. The differential channels are compliant with High Speed USB 2.0, Full Speed USB 1.1, Low Speed USB 1.0 and any generic UART protocol. The multi-purpose audio path is capable of passing signals with negative voltages as low as 3 V below ground and features shunt resistors to reduce Pop and Click noise in the audio system.

For the NL3S22AH, the audio path (AUDP/AUDN) will be selected with SEL=0 with the device enabled (EN = 1). For the NL3S22UH, the high speed data path (HDP/HDN) will be selected with SEL=0 with the device enabled (EN = 1).

### Features

- V<sub>CC</sub> Range: 2.7 V to 3.7 V
- Control Pins Compatible with 1.8 V Interfaces
- I<sub>CC</sub>: 60 μA (Typ)
- ESD Performance: 2 kV HBM
- Available in 1.4 mm x 1.8 mm UQFN10
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### High Speed Data Path

- Input Signal Range: 0 V to 4.5 V
- R<sub>DS(on)</sub>: 5.4 Ω (Typ)
- C<sub>ON</sub>: 8.7 pF (Typ)
- Data Rate: USB 2.0-Compliant – up to 480 Mbps
- Bandwidth: >811 MHz

### Audio Path

- Input Signal Range: -3.0 V to 3.0 V
- R<sub>DSON</sub>: 0.56 Ω (Typ)
- R<sub>ON(FLAT)</sub>: 0.004 Ω (Typ)
- THD+N:
  - 113 dB (R<sub>L</sub> = 32 Ω / V<sub>IS</sub> = 1.0 V<sub>RMS</sub>)
  - 109 dB (R<sub>L</sub> = 16 Ω / V<sub>IS</sub> = 0.4 V<sub>RMS</sub>)

### Applications

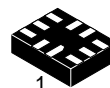
- Smartphones
- Tablets
- USB 2.0 Hosts/Peripherals
- Audio / High-Speeds Data Switching
- USB Type-C Switching



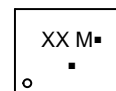
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### MARKING DIAGRAM



UQFN10  
CASE 488AT



XX = AY for NL3S22AHMUTAG  
= DW for NL3S22UHMUTAG

M = Date Code  
▪ = Pb-Free Device

(Note: Microdot may be in either location)

### ORDERING INFORMATION

Device	Package	Shipping†
NL3S22AHMUTAG	UQFN10 (Pb-Free)	3000 / Tape & Reel
NL3S22UHMUTAG	UQFN10 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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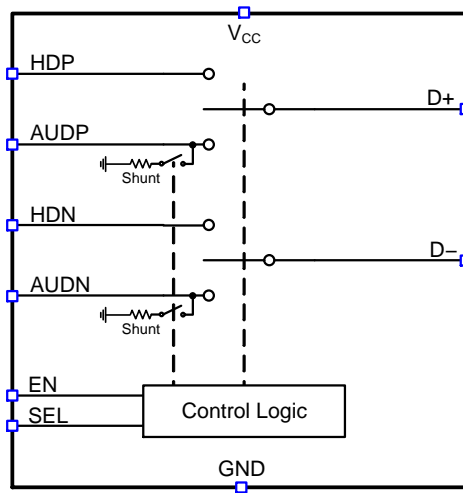


Figure 1. Block Diagram

## FUNCTION TABLE

EN	SEL		Shunt Status	D+/D- Function
	NL3S22AH	NL3S22UH		
0	X	X	ON	No Connect (Power Down)
1	0	1	OFF	AUDP/AUDN
1	1	0	ON	HDP/HDN

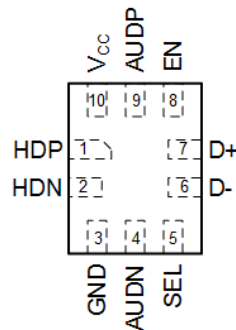


Figure 2. UQFN10 – Top Through View

## PIN DESCRIPTION

Pin Name	Pin	Description
HDP	1	High Speed Differential Data (+)
HDN	2	High Speed Differential Data (-)
GND	3	Ground
AUDN	4	Audio Signal (-)
SEL	5	Function Select
D-	6	Audio/Data Common I/O (-)
D+	7	Audio/Data Common I/O (+)
EN	8	Chip Enable
AUDP	9	Audio Signal (+)
V <sub>CC</sub>	10	Power Supply

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## MAXIMUM RATINGS

Rating	Symbol	Value	Unit
$V_{CC}$	Positive DC Supply Voltage	-0.5 to +4.2	V
$V_{IS}$	Analog Input/Output Voltage	HDP, HDN -0.5 to +5.5	V
		AUDP, AUDN -3.5 to +4.2	
		D+, D- -3.5 to +5.5	
$V_{IN}$	Digital Control Pin Voltage on EN, SEL	-0.5 to $V_{CC} + 0.5$	V
$T_s$	Storage Temperature	-55 to +150	°C
$T_L$	Lead Temperature, 1 mm from Case for 10 seconds	260	°C
$T_J$	Junction Temperature Under Bias	150	°C
MSL	Moisture Sensitivity (Note 1)	Level 1	
$I_{LU}$	Latchup Current (Note 2)	±100	mA
ESD	ESD Protection (Note 3)	Human Body Model	2000
		Charged Device Model	2000

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Moisture Sensitivity Level (MSL): 1 per IPC/JEDEC standard: J-STD-020A.
2. Latch up Current Maximum Rating: ±100 mA per JEDEC standard: JESD78.
3. This device series contains ESD protection and passes the following tests:  
Human Body Model (HBM) ±2.0 kV per JEDEC standard: JESD22-A114 for all pins.

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
$V_{CC}$	Positive DC Supply Voltage	2.7	3.7	V
$V_{IS}$	Switch Input / Output Voltage (Note 4)	HDP, HDN	0	4.5
		AUDP, AUDN	-3.0	3.0
		D+, D-	-3.0	4.5
$V_{IN}$	Digital Control Input Voltage	GND	$V_{CC}$	V
$T_A$	Operating Temperature Range	-40	+85	°C

4. If the audio channel is not in use, it is recommended that no signals are applied on the audio inputs AUDN and AUDP.

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**DC ELECTRICAL CHARACTERISTICS** (Typical values are at  $V_{CC} = +3.6\text{ V}$  and  $T_A = +25^\circ\text{C}$ , unless otherwise specified)

Symbol	Parameter	Test Conditions	$V_{CC}$ (V)	-40 °C to 85 °C			Unit
				Min	Typ	Max	

## POWER SUPPLY

$I_{CC}$	Supply Current	$EN = 1, I_{IS} = 0\text{ mA}$	3.6	-	60	100	$\mu\text{A}$
		$EN = 0$ (Power Down)		-	-	1.0	

## Control Logic (EN, SEL)

$V_{IH}$	Input High Voltage		3.6	1.4	-	-	V
			2.7	1.3	-	-	
$V_{IL}$	Input Low Voltage		3.6	-	-	0.4	V
			2.7	-	-	0.4	
$V_{IHYS}$	Input Hysteresis		2.7 – 3.6	-	250	-	mV
$I_{IN}$	Leakage Current		2.7 – 3.6	-	-	$\pm 100$	nA

## AUDIO SWITCH (AUDP/AUDN ↔ D+/D-)

$R_{ON}$	ON-Resistance	$V_{IS} = -3.0\text{ V to }3.0\text{ V}, I_{IS} = 50\text{ mA}$	3.0	-	0.56	0.73	$\Omega$
$\Delta R_{ON}$	ON-Resistance Matching Between Channels	$V_{IS} = -3.0\text{ V to }3.0\text{ V}, I_{IS} = 50\text{ mA}$	3.0	-	0.07	-	$\Omega$
$R_{FLAT(ON)}$	ON Resistance Flatness	$V_{IS} = -3.0\text{ V to }3.0\text{ V}, I_{IS} = 50\text{ mA}$	3.0	-	0.004	-	$\Omega$
$R_{SH}$	Shunt Resistance		3.6	-	110	200	$\Omega$
$I_{SW(OFF)}$	OFF-State Leakage	$EN = 0, V_{IS} = 3.0\text{ V at D+/D-}$	3.6	-	-	$\pm 200$	nA
$I_{SW(ON)}$	ON-State Leakage	$V_{IS} = 0\text{ V to }3.0\text{ V at D+/D-},$ $AUDP = AUDD = \text{open}$	3.6	-	$\pm 2.2$	$\pm 3.0$	$\mu\text{A}$

## DATA SWITCH (HDP/HDN ↔ D+/D-)

$R_{ON}$	ON-Resistance	$V_{IS} = 0\text{ V to }1.7\text{ V}, I_{IS} = 15\text{ mA}$	3.0	-	5.4	6.63	$\Omega$
$\Delta R_{ON}$	ON-Resistance Matching Between Channels	$V_{IS} = 0\text{ V to }1.7\text{ V}, I_{IS} = 15\text{ mA}$	3.0	-	0.2	-	$\Omega$
$R_{FLAT(ON)}$	ON Resistance Flatness	$V_{IS} = 0\text{ V to }1.7\text{ V}, I_{IS} = 15\text{ mA}$	3.0	-	0.002	-	$\Omega$
$I_{SW(OFF)}$	OFF-State Leakage	$EN = 0, V_{IS} = 0\text{ V to }3.6\text{ V}$	3.6	-	-	$\pm 200$	nA
$I_{SW(ON)}$	ON-State Leakage	$V_{IS} = 0\text{ V to }3.6\text{ V}$	3.6	-	-	$\pm 200$	nA

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## AC ELECTRICAL CHARACTERISTICS (Typical values are at $V_{CC} = +3.6\text{ V}$ and $T_A = +25^\circ\text{C}$ )

Symbol	Parameter	Test Conditions	$V_{CC}$ (V)	-40 °C to 85 °C			Unit
				Min	Typ	Max	
<b>AUDIO SWITCH (AUDP/AUDN ↔ D+/D-)</b>							
THD	Audio THD	$f = 20\text{ Hz to }20\text{ kHz}$ , $V_{IS} = 1.0\text{ V}_{RMS}$ , DC Bias = 0 V, $R_L = 32\ \Omega$ $V_{IS} = 0.4\text{ V}_{RMS}$ , DC Bias = 0 V, $R_L = 16\ \Omega$	2.7 – 3.6	–	–113 –109	–	dB
PSRR	Power Supply Ripple Rejection	From $V_{CC}$ unto AUDP/AUDN, $f = 217\text{ Hz}$ , $R_L = 16\ \Omega$	2.7 – 3.6	–	106	–	dB

## DATA SWITCH (HDP/HDN ↔ D+/D-)

$C_{ON}$	Equivalent ON-Capacitance	Switch ON, $f = 1\text{ MHz}$	3.6	–	8.7	10	pF
$C_{OFF}$	Equivalent OFF-Capacitance	Switch OFF, $f = 1\text{ MHz}$	3.6	–	1.8	–	pF
$D_{IL}$	Differential Insertion Loss	$f = 10\text{ MHz}$	2.7 – 3.6	–	–0.5	–	dB
		$f = 800\text{ MHz}$	2.7 – 3.6	–	–2.8	–	
$D_{ISO}$	Differential Off-Isolation	$f = 10\text{ MHz}$	2.7 – 3.6	–	–54	–	dB
		$f = 800\text{ MHz}$	2.7 – 3.6	–	–25	–	
$D_{CTK}$	Differential Crosstalk	$f = 10\text{ MHz}$	2.7 – 3.6	–	–62	–	dB
		$f = 800\text{ MHz}$	2.7 – 3.6	–	–28	–	
PSRR	Power Supply Ripple Rejection	From $V_{CC}$ unto D+/D-, $f = 217\text{ Hz}$ , $R_L = 50\ \Omega$	2.7 – 3.6	–	111	–	dB

## DYNAMIC TIMING

$t_{PD}$	Propagation Delay (Notes 5 and 6)	$V_{NOH}$ or $V_{NCH} = 0\text{ V}$ , $R_L = 50\ \Omega$	2.7 – 3.6	–	0.25	–	ns
$t_{EN}$	Enable Time, EN to HDx EN to AUDx	$V_{IS} = 1\text{ V}$ , $R_L = 50\ \Omega$ , $C_L = 7\text{ pF}$ (fixture only)	2.7 – 3.6	–	2.1	–	$\mu\text{s}$
				–	5.1	–	
$t_{DIS}$	Disable Time, EN to HDx EN to AUDx	$V_{IS} = 1\text{ V}$ , $R_L = 50\ \Omega$ , $C_L = 7\text{ pF}$ (fixture only)	2.7 – 3.6	–	157	–	ns
				–	53	–	
$t_{ON}$	Turn-On Time, SEL to HDx SEL to AUDx	$V_{IS} = 1\text{ V}$ , $R_L = 50\ \Omega$ , $C_L = 7\text{ pF}$ (fixture only)	2.7 – 3.6	–	0.3	–	$\mu\text{s}$
				–	3.4	–	
$t_{OFF}$	Turn-Off Time, SEL to HDx SEL to AUDx	$V_{IS} = 1\text{ V}$ , $R_L = 50\ \Omega$ , $C_L = 7\text{ pF}$ (fixture only)	2.7 – 3.6	–	157	–	ns
				–	44	–	
$t_{INIT}$	Initialization Time (Notes 5 and 7), $V_{CC}$ to D+/D-	$V_{IS} = 1\text{ V}$ , $R_L = 50\ \Omega$ , $C_L = 7\text{ pF}$ (fixture only)	2.7 – 3.6	150	–	–	$\mu\text{s}$
$t_{sk(b-b)}$	Bit to bit skew	Within the same differential channel	2.7 – 3.6	–	5	–	ps
$t_{sk(ch-ch)}$	Channel to channel skew	Maximum skew between all channels	2.7 – 3.6	–	5	–	ps

5. Guaranteed by design.

6. No other delays than the RC network formed by the load resistance and the load capacitance of the switch are added on the bus. For a 10 pF load, this delay is 5 ns which is much smaller than rise and fall time of typical driving systems. Propagation delays on the bus are determined by the driving circuit on the driving side and its interactions with the load of the driven side.

7. Wait time required after  $V_{CC}$  power-up to operating level before data access is valid.

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## PARAMETER MEASUREMENT INFORMATION

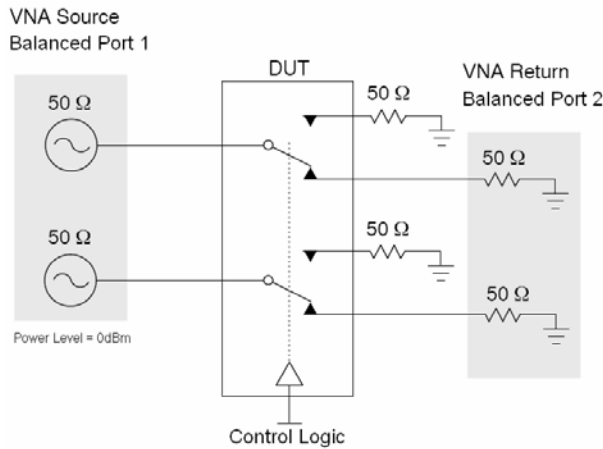


Figure 3. Differential Insertion Loss ( $S_{DD21}$ )

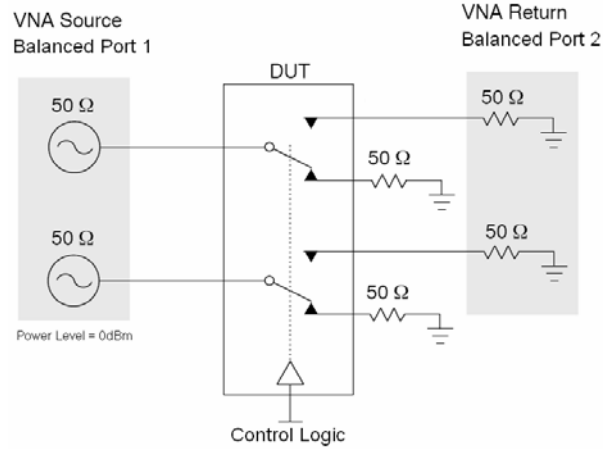


Figure 4. Differential Off Isolation ( $S_{DD21}$ )

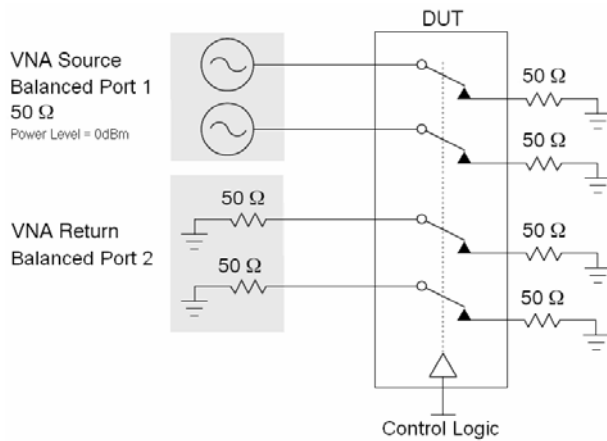


Figure 5. Differential Crosstalk ( $S_{DD21}$ )

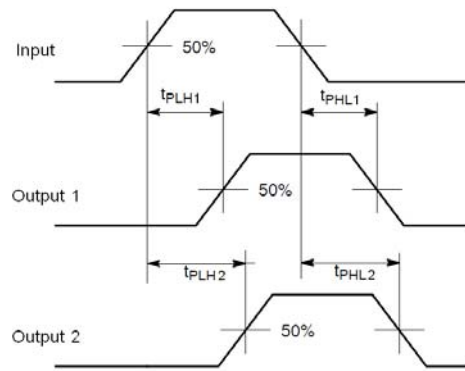


Figure 6. Bit-to-Bit and Channel-to-Channel Skew

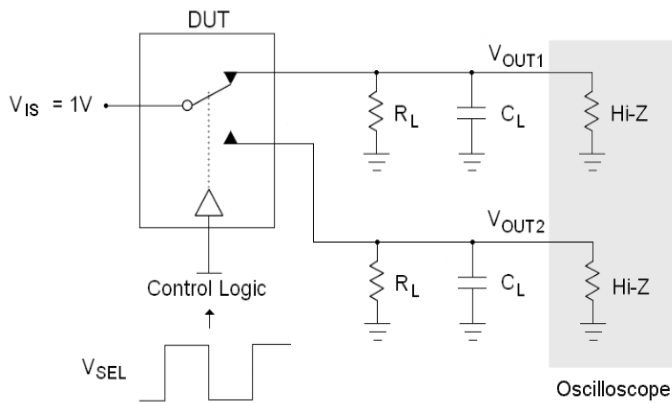


Figure 7.  $t_{ON}$  and  $t_{OFF}$

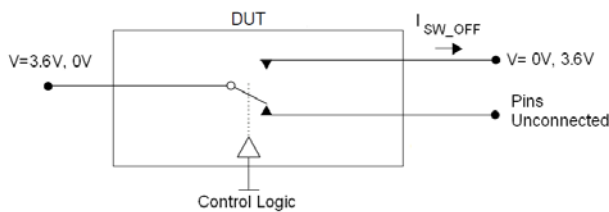
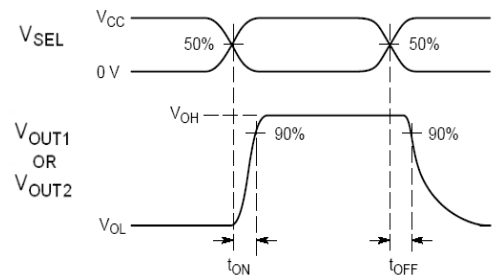


Figure 8. Off State Leakage

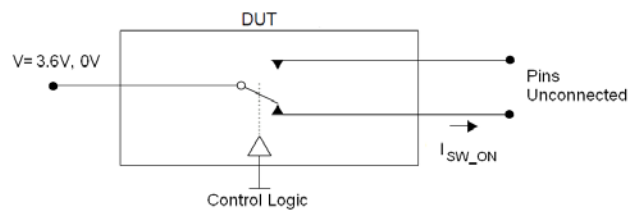


Figure 9. On State Leakage

# NL3S22AH, NL3S22UH

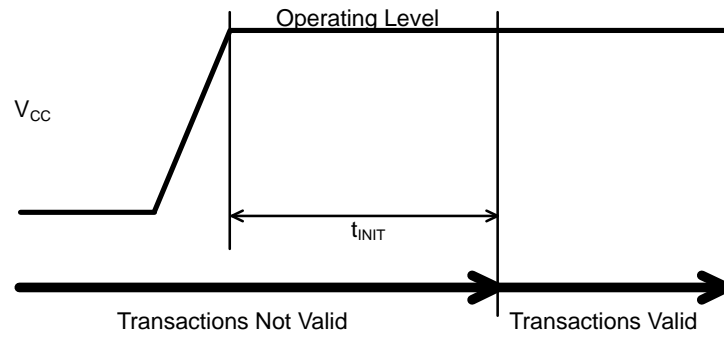


Figure 10.  $t_{INIT}$ , Initialization Time

# NL3S22AH, NL3S22UH

## TYPICAL OPERATING CHARACTERISTICS

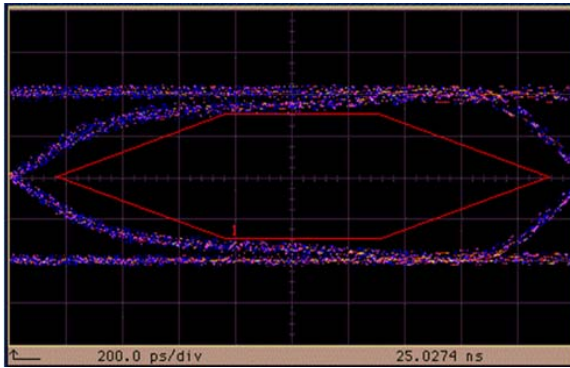


Figure 11. USB 2.0 High Speed Eye Diagram

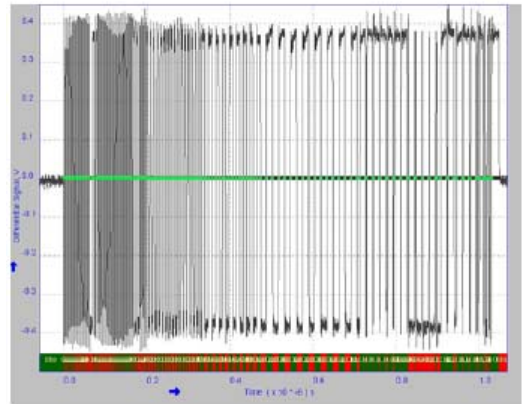


Figure 12. USB 2.0 High Speed Pattern

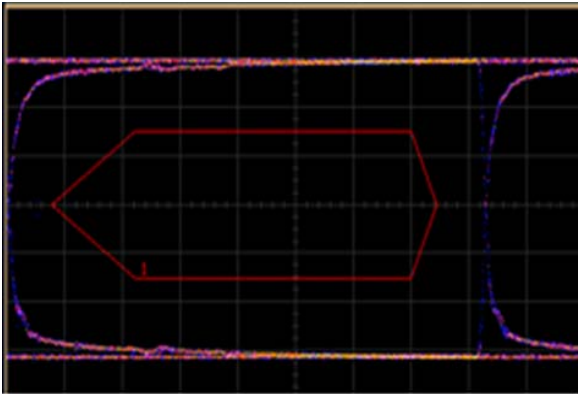


Figure 13. USB 1.1 Full Speed Eye Diagram

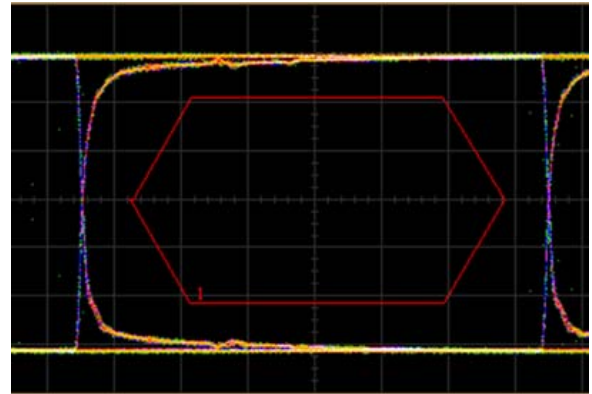


Figure 14. USB 1.0 Low Speed Eye Diagram

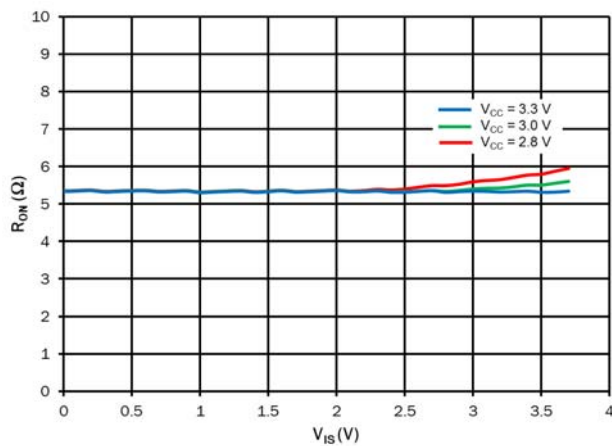


Figure 15. Data Path On Resistance

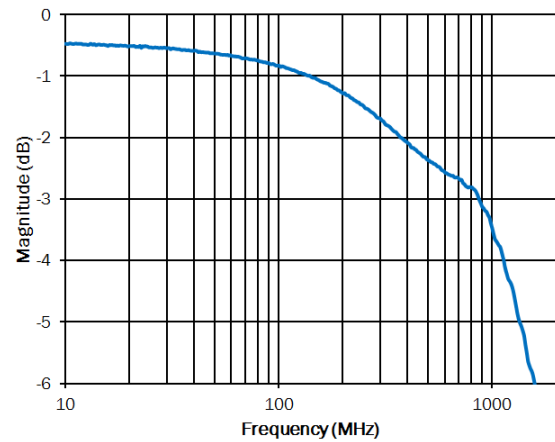
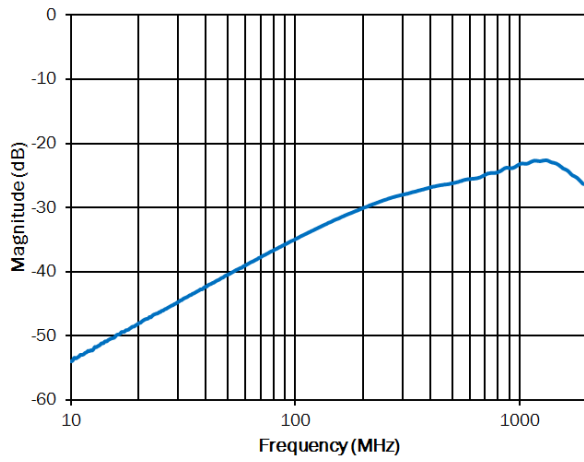


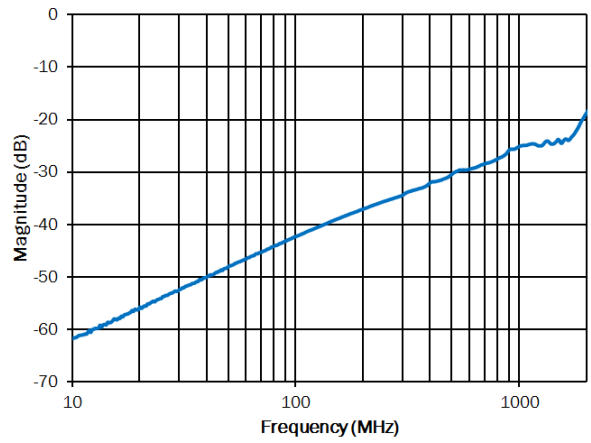
Figure 16. Data Switch Differential Insertion Loss



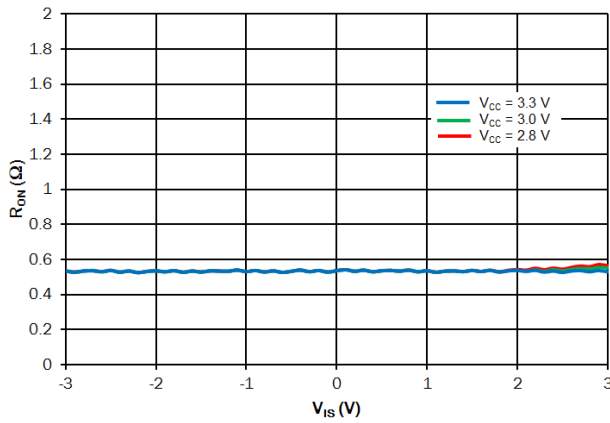
# NL3S22AH, NL3S22UH



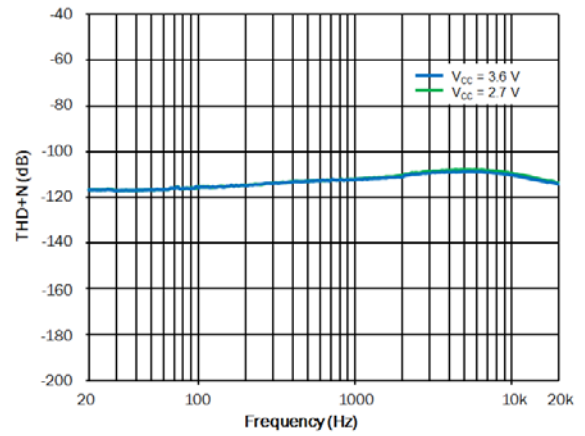
**Figure 17. Data Switch Differential Off-Isolation**



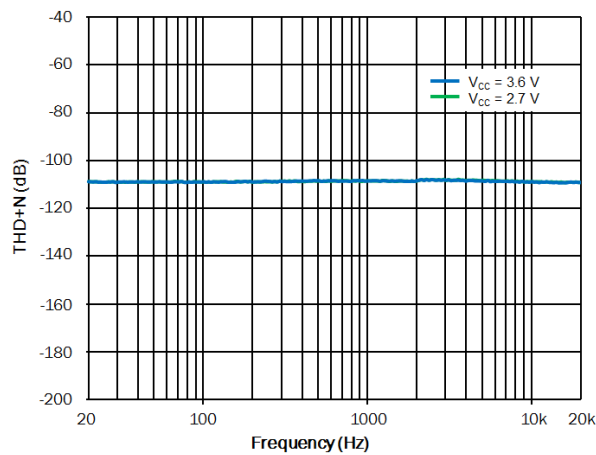
**Figure 18. Data Switch Differential Crosstalk**



**Figure 19. Audio Path On Resistance**



**Figure 20. Audio THD+N  
( $R_L = 32 \Omega$ ,  $V_{IS} = 1.0 V_{RMS}$ )**



**Figure 21. Audio THD+N  
( $R_L = 16 \Omega$ ,  $V_{IS} = 0.4 V_{RMS}$ )**

# MECHANICAL CASE OUTLINE

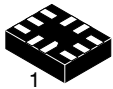
## PACKAGE DIMENSIONS

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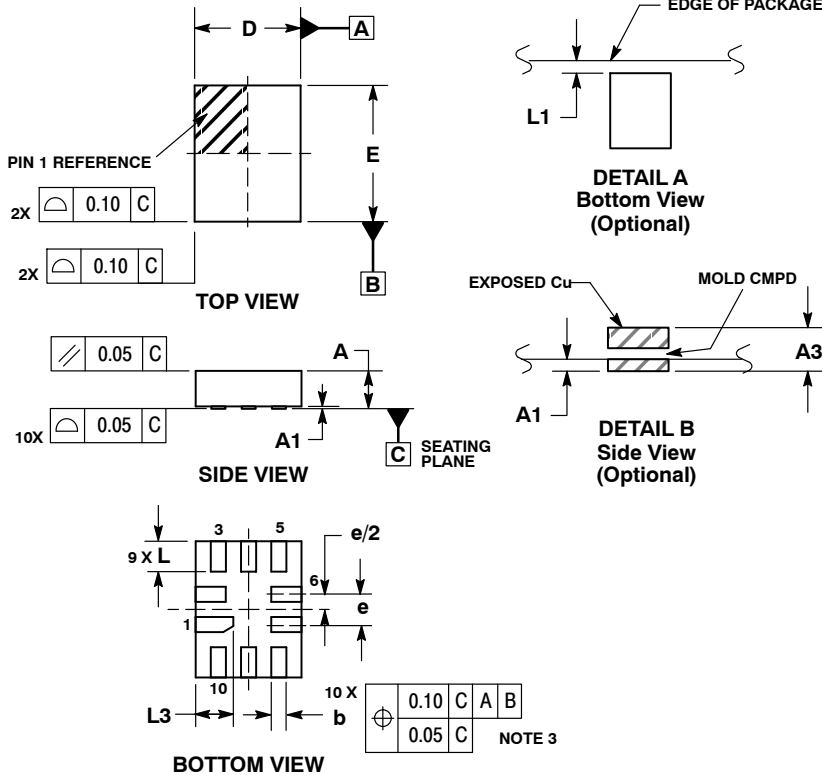


### UQFN10 1.4x1.8, 0.4P CASE 488AT-01 ISSUE A

DATE 01 AUG 2007



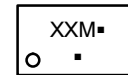
SCALE 5:1



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

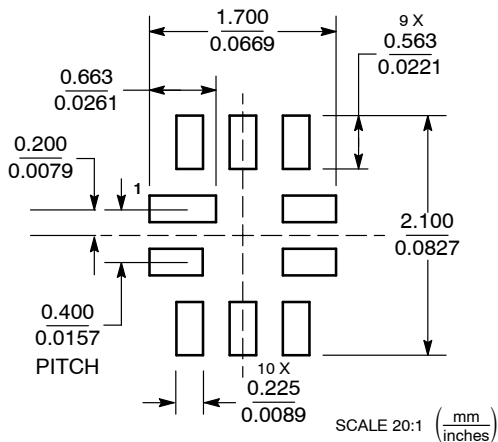
### GENERIC MARKING DIAGRAM\*



- XX = Specific Device Code
  - M = Date Code
  - = Pb-Free Package
- (Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

### MOUNTING FOOTPRINT



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<b>DESCRIPTION:</b>	<b>10 PIN UQFN, 1.4 X 1.8, 0.4P</b>	<b>PAGE 1 OF 1</b>

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**Europe, Middle East and Africa Technical Support:**

Phone: 00421 33 790 2910

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